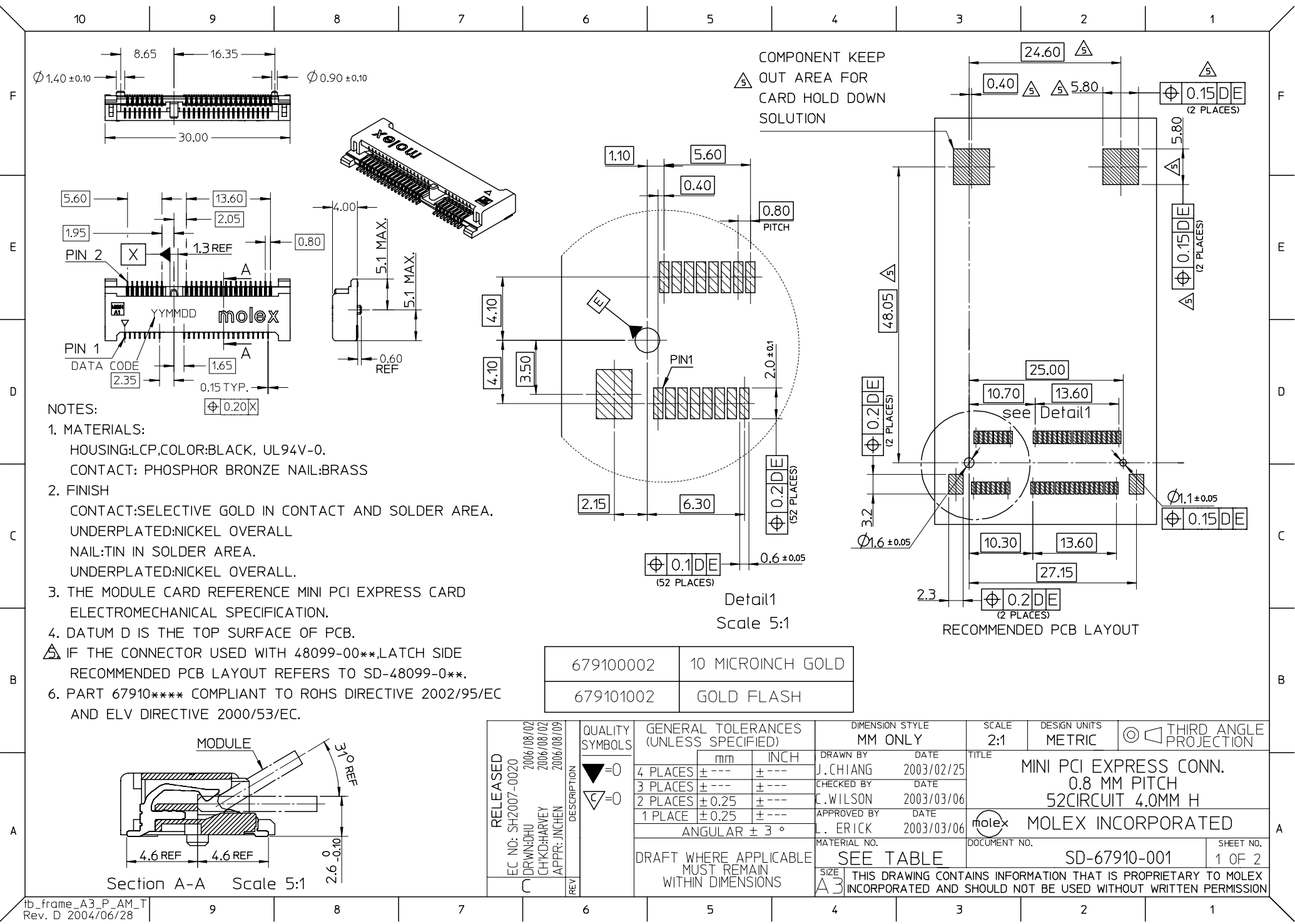




NOTES:

- 1. MATERIALS:
HOUSING:LCP,COLOR:BLACK, UL94V-0.
CONTACT: PHOSPHOR BRONZE NAIL:BRASS
- 2. FINISH
CONTACT:SELECTIVE GOLD IN CONTACT AND SOLDER AREA.
UNDERPLATED:NICKEL OVERALL
NAIL:TIN IN SOLDER AREA.
UNDERPLATED:NICKEL OVERALL.
- 3. THE MODULE CARD REFERENCE MINI PCI EXPRESS CARD
ELECTROMECHANICAL SPECIFICATION.
- 4. DATUM D IS THE TOP SURFACE OF PCB.
- 5. IF THE CONNECTOR USED WITH 48099-00**,LATCH SIDE
RECOMMENDED PCB LAYOUT REFERS TO SD-48099-0**.
- 6. PART 67910**** COMPLIANT TO ROHS DIRECTIVE 2002/95/EC
AND ELV DIRECTIVE 2000/53/EC.

679100002	10 MICROINCH GOLD
679101002	GOLD FLASH

RELEASED EC NO: SH2007-0020 2006/08/02 DRWN:DHU CHKD:HARVEY 2006/08/02 APPR: INCHEM 2006/08/09	DESCRIPTION	QUALITY SYMBOLS ▽=0 ▽C=0	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE MM ONLY		SCALE 2:1	DESIGN UNITS METRIC	THIRD ANGLE PROJECTION		
			mm	INCH	DRAWN BY	DATE	TITLE MINI PCI EXPRESS CONN. 0.8 MM PITCH 52CIRCUIT 4.0MM H				
			4 PLACES	± ---	± ---	J. CHIANG					
			3 PLACES	± ---	± ---	CHECKED BY	DATE	MOLEX INCORPORATED			
2 PLACES	± 0.25	± ---	C. WILSON	2003/03/06							
1 PLACE	± 0.25	± ---	APPROVED BY	DATE	MOLEX						
ANGULAR ± 3 °			L. ERICK	2003/03/06						DOCUMENT NO. SD-67910-001	
DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS			MATERIAL NO.		SHEET NO. 1 OF 2						
			SEE TABLE		SD-67910-001						
REV	C		SIZE A3		THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION						

